Review of single photon imaging techniques with fast timing for applications in space and particle physics, and the life sciences

J.S.Lapington and D.O.Kataria



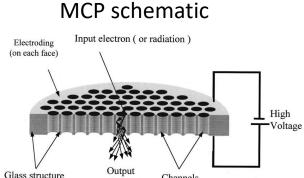


Scope

- Vacuum tube devices
 - Imaging and timing with MCP detectors
 - MCP-based Imaging photomultipliers
 - Hybrid MCP-based devices
- Solid state devices
 - Silicon photomultiplier arrays CTA SST camera
 - Digital SiPMs
 - Large format SPAD Arrays
- NOT A COMPREHENSIVE LIST

Imaging and Timing with MCPs

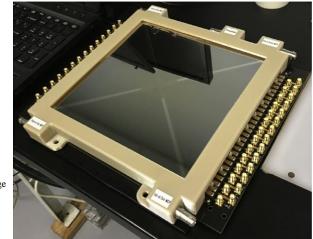
- Monolithic array of miniature electron multipliers
- Intrinsic imaging capability with suitable readout
- Large formats available
- Miniaturization \rightarrow improved timing cf. conventional PMTs
 - SPTR ~30 ps rms
- But:
 - Broad pulse height distribution
 - Limited lifetime/charge extraction
 - Vacuum tube requirement
 - Photocathode limitations
 - High voltage •



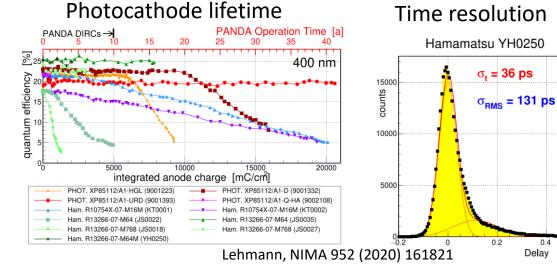
electrons

Channels

LAPPD 195 mm × 195 mm







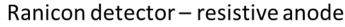
Jon Lapington - Review of photon timing and imaging detectors - PSD12, Birmingham, September 2021

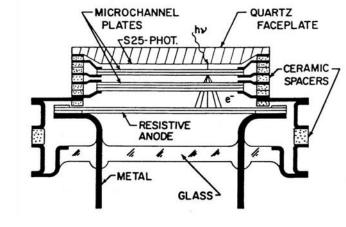
0.4

Delay [ns]

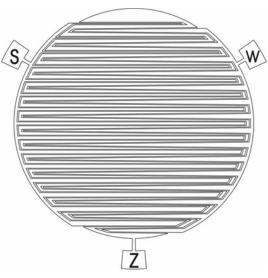
Direct electronic readouts

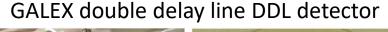
- Global charge division
 - Resistive anode,
 - Wedge and strip, Vernier anode
 - Delay line
- Features:
 - Low electronics channel count originally great advantage
 - Flexible format, custom manufacture
 - But serial event processing limits count rate (especially as electronics improve)





Wedge & strip anode

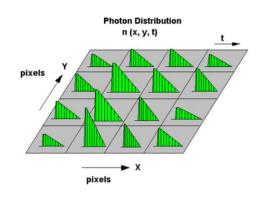


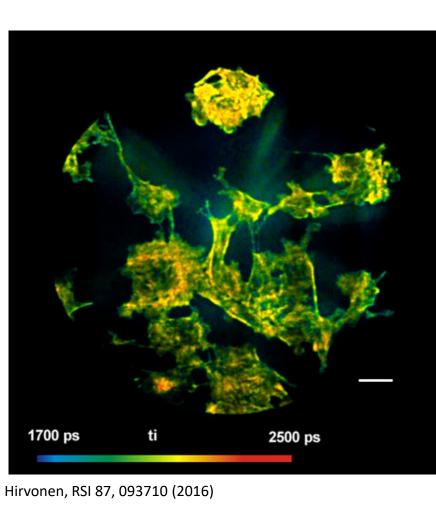


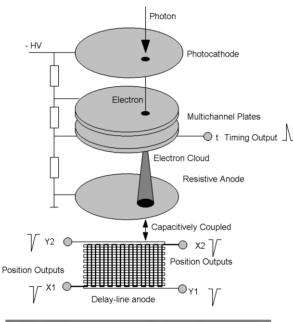


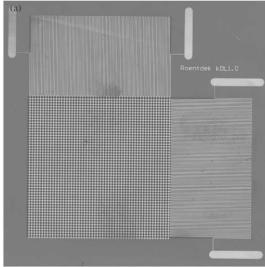
Direct electronic readouts

- Crossed Delay Line
 - Wide-field TCSPC FLIM
 - Single photon x,y,t → fluorescence decay time



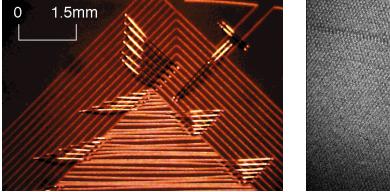


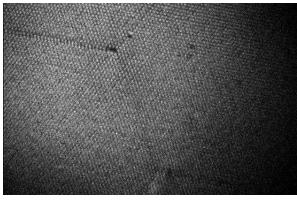




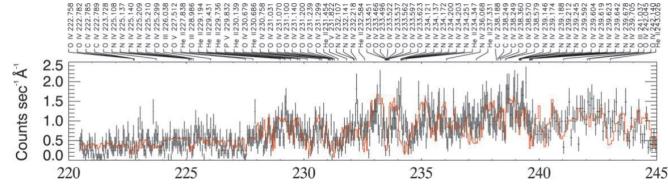
Direct electronic readouts

- Vernier Anode
 - UV Astronomy Spectroscopy
 - Cyclically varying electrodes
 - Utilise a Vernier position encoding technique
 - Spatial resolution greater than charge measurement accuracy
 - Flight heritage
 - Leicester/MSSL J-PEX sounding rocket EUV spectrometer





Close-up of the nine-electrode pattern MCP pore limited image resolution

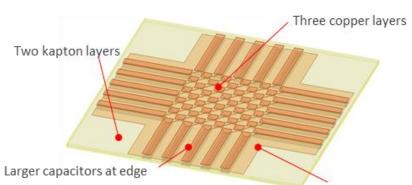


Conneely, Proc. SPIE (2013), 8859, 88590W

MCP-based Imaging photomultipliers

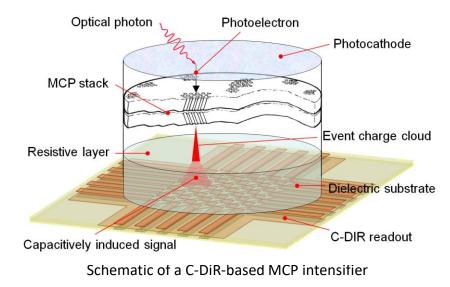
Direct electronic readouts

- Capacitive division readout (C-DiR)
 - Capacitively coupled electrode array
 - Signal collected at 4 corner nodes
 - Low capacitance array high speed
 - Can exploit full MCP timing potential
 - Spatial resolution greater than charge measurement accuracy
 - Flight heritage
 - Leicester/MSSL J-PEX sounding rocket EUV spectrometer



Schematic of the C-DiR readout

3 x 3 1 mm pitch pinhole mask imaged using ToT with NINO + HPTDC electronics

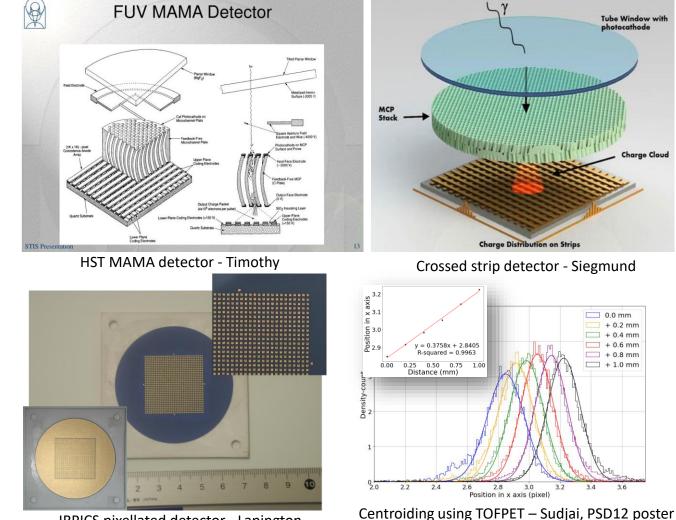


Direct electronic readouts

- Localised charge division
 - Pixelated electronic readout
 - Strip readout –cross-strip, (began with MAMA on HST)

• Features

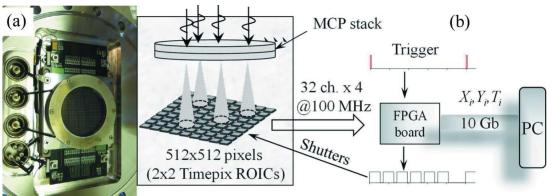
- Requires much higher channel count
- Finer structure manufacture can be more challenging
- Allows parallel event readout \rightarrow higher throughput
- Smaller geometry → lower noise, lower gain, higher resolution, faster electronics, higher count rate
- Timing electronics dependent
- Centroiding \rightarrow sub-pitch resolution
 - Centroiding results using PetSYS TOFPET TDC system
 - Time-over-threshold \rightarrow signal amplitude



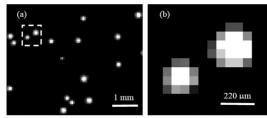
IRPICS pixellated detector - Lapington Jon Lapington - Review of photon timing and imaging detectors - PSD12, Birmingham, September 2021

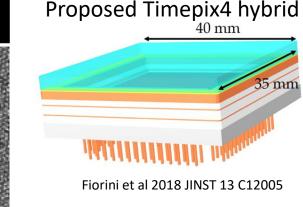
Vacuum tube hybrid solutions

- ICCD, ICMOS no picosecond timing
 - 1MHz CMOS at 182x32 yesterday
- Medipix/Timepix as a direct MCP event collector
 - no Si detection element
- High pixel count and readout speed \rightarrow very high throughout
- Can't achieve MCP-limited time resolution, but:
 - First gen Timepix frame-based 10 μs
 - Timepix3 event-driven mode \rightarrow 1.6 ns
 - Timepix4 \rightarrow 200 ps
- Spatial resolution
 - 6 μm with event centroiding pore limited resolution
 - ToT charge measurement at MCP gain ~10⁴ e⁻
 - Good for high rate and long lifetime
 - Potential issues:
 - Vacuum tube processing and lifetime
 - Mechanical integration and feedthroughs



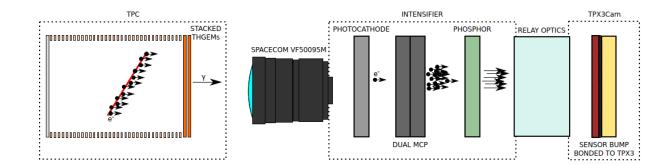
Tremsin, J. Synchrotron Rad. (2021). 28, 1069–1080



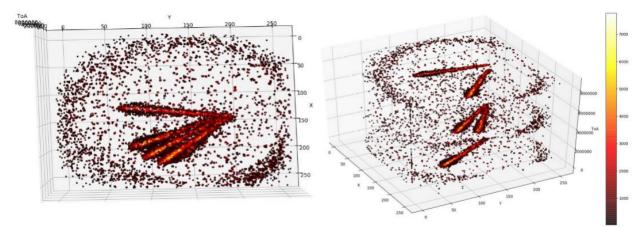


Other hybrid solutions

- Intensified optical Timepix
 - 3D TPC readout
 - MCP intensifier + Timepix 3 camera
 - light sensitive silicon sensor bump bonded onto a TPX3 chip
 - 256 x 256 pixel² format, 0.7 mm/pixel
 - ToA \rightarrow 1.6 ns time resolution \rightarrow Z resolution < 1mm



2D versus 3D visualization of TPC readout using Timepix3 camera

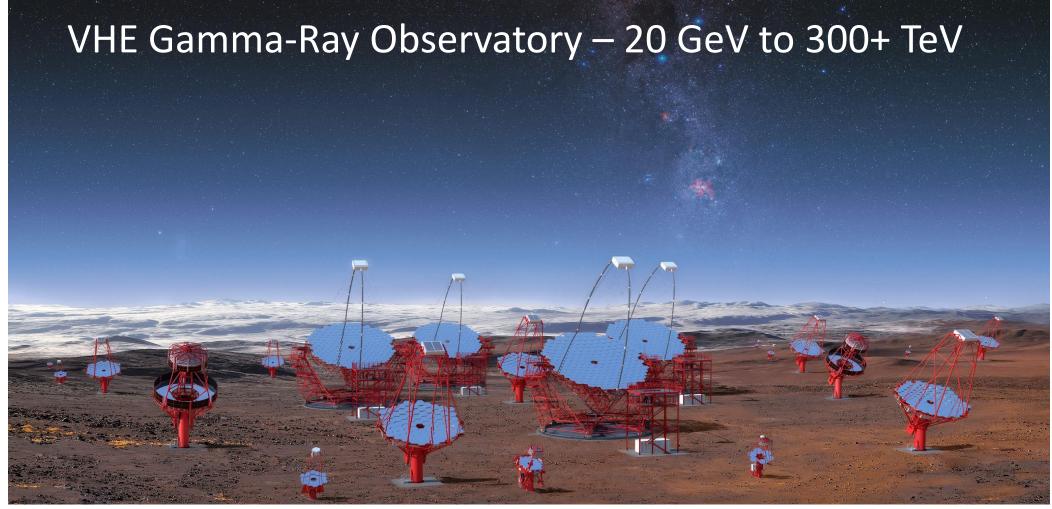


Roberts et al 2019 JINST 14 P06001

Solid State devices

- Silicon photomultiplier arrays CTA SST camera
- Linearly-graded SiPMs
- Digital SiPM
- Large format SPAD Arrays

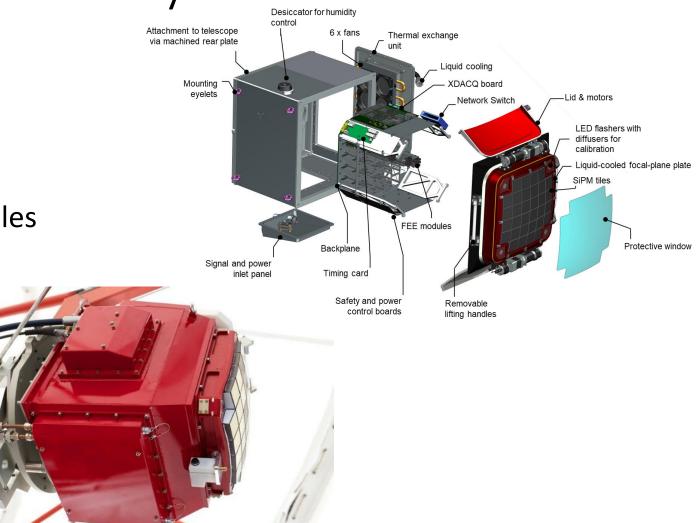
Cherenkov Telescope Array – SiPM array



Jon Lapington - Review of photon timing and imaging detectors - PSD12, Birmingham, September 2021

Silicon photomultiplier arrays

- Small-sized Telescope for CTA
 - SiPM-based camera
 - 2048 6x6 mm2 SiPM pixels
 - Organised as separate 32 modules
 - 1 GSa/s waveform capture per pixel using TARGET ASIC
 - Time resolution: <150 ps



SST Prototype Camera Module

Connection to the backplane: raw data, trigger, clock signals, electronics power (12 V) and SiPM bias voltage (~70 V)

Power board provides low voltages, SiPM bias voltage trimming and monitoring

Shielding for all switching components and ASICs

SiPM bias voltage

Low-voltage power on separate cable to buffer

Primary board and auxiliary boards each contain 32 channels of readout

TARGET-C and T5TEA ASICs provide 16 channels of digitisation and triggering. Slow ADCs provide a parallel readout stream for monitoring of DC signal component

Amplifier and shaper circuits for optimal signal-to-noise

Cables used to remove radius of curvature in focal plane

Samtec individually shielded coaxial ribbon cables for analogue signals

Temperature sensor

Copper heat-sink arrangement to focal

SiPM Tile

September 2021

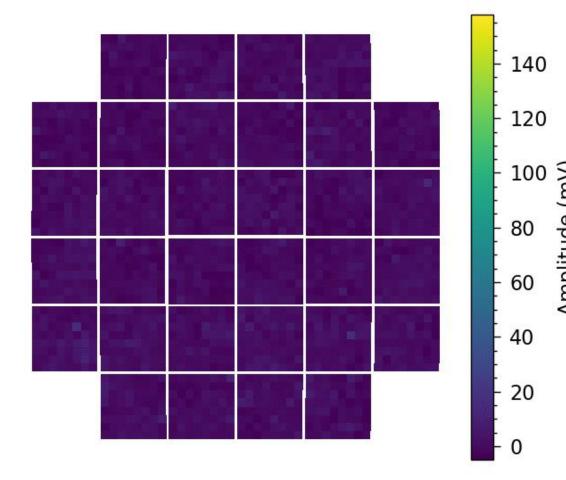
-50 mm

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On-sky camera tests with Italian ASTRI telescope – Serra La Nave Observatory, Mt. Etna

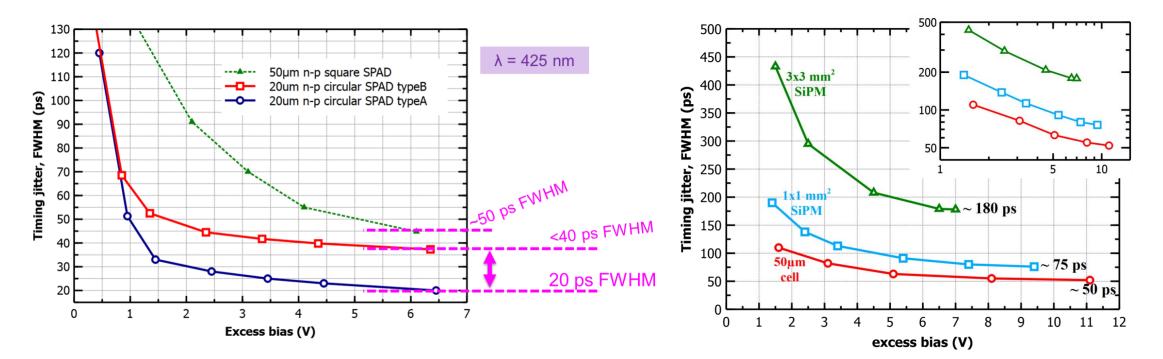




SPAD and SiPM time resolution

SPTR of Single SPADs



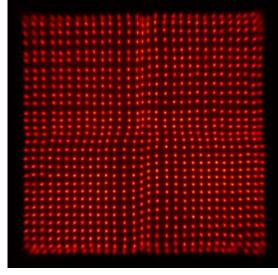


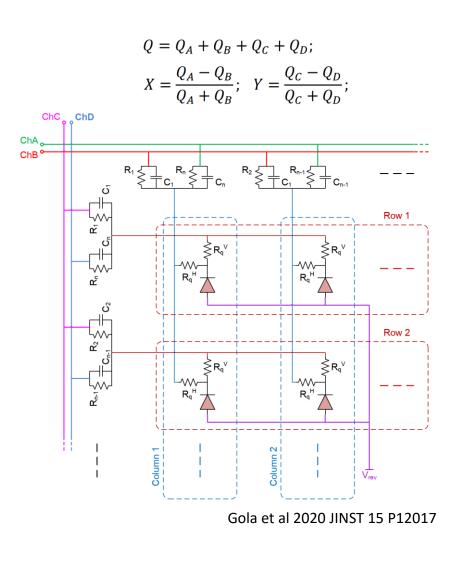
Mazzi - FBK SiPM technology

Linearly Graded SiPMs

- Each microcell has 2 quench resistors and resistive divider
- Event measurement at 4 readout nodes → x,y cell identification

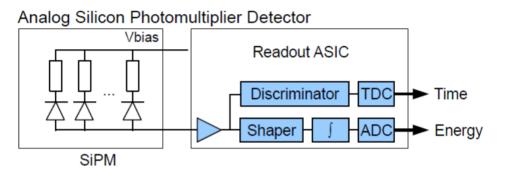
2 x 2 LG-SiPMs with scintillators for small animal PET



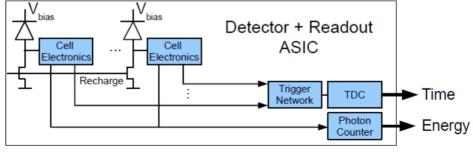


Digital Silicon photomultipliers

Original Philips Digital SiPM concept



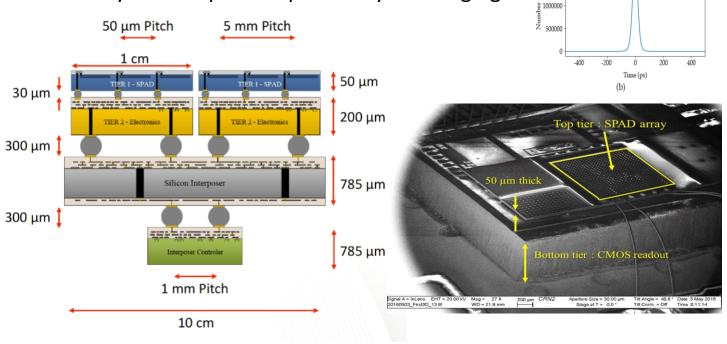
Digital Silicon Photomultiplier Detector



IEEE Nuclear Science Symposium / Medical Imaging Conference, Orlando, FL October 28, 2009

TRIUMF-Sherbrooke 3D digital SiPM

- Primarily developed for PET, not imaging
- TSMC CMOS 65 nm technology 256 pixels
- Optimizes array SPTR for PET
- Skew correction per SPAD \rightarrow 18 ps rms jitter
- Identity of fired pixel \rightarrow possibility for imaging



12000 12000

8000

6000

4000

2000000

1500000

400

-200

Ó

Time (ps)

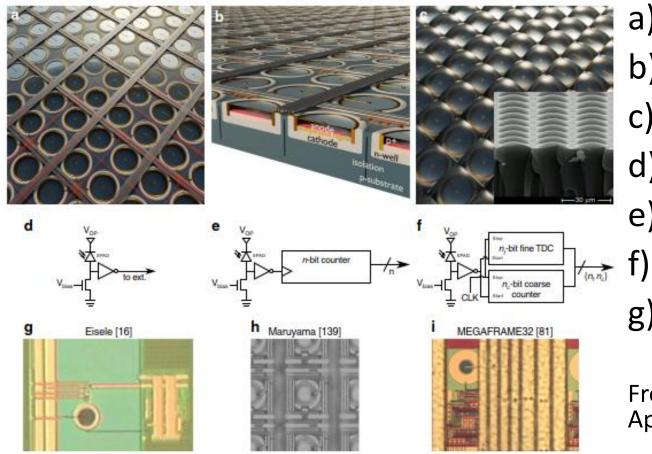
(a)

200

18 ps rms

400

Spad Array Architectures

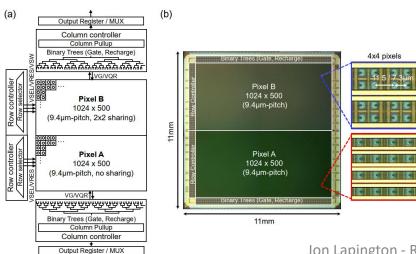


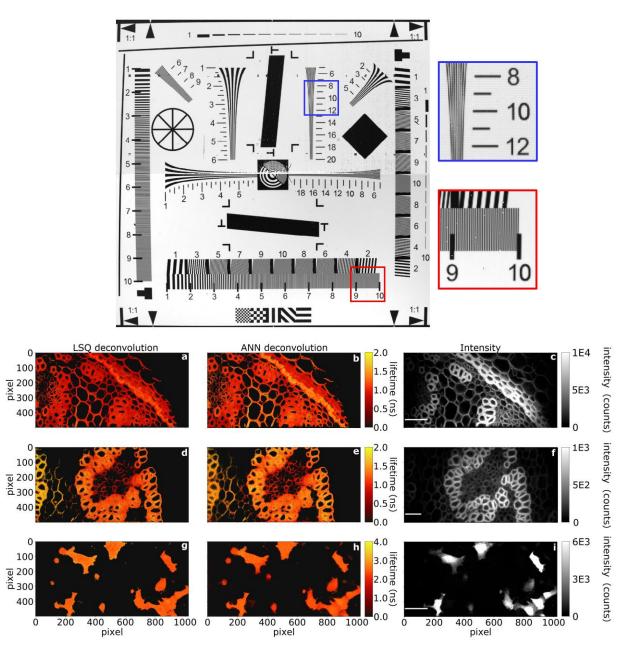
- a) Top view
- b) Cross-section
- c) SEm inset view
- d) Photon to pulse electronics
- e) Photon counting electronics
 - Photon timing electronics
- g) to i) Example pixel micrographs

From: Bruschini et al. Light: Science & Applications (2019)8:87

Large SPAD arrays

- First 1M pixel SPAD camera
- Time-gated:
 - Minimum gate length 3.8 ns
 - Gate variation 120 ps FWHM
 - Frame rate 24 kfps
- Used for FLIM in gated mode
- ANN for data analysis
- Many devices for biophotonics see Bruschini et al. Light: Science & Applications (2019) 8:87



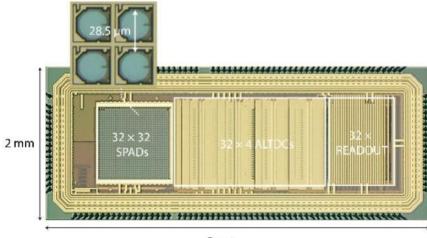


Large SPAD arrays

- SPAD arrays also available for TCSPC
- With TDCs and high rate capabilities
- LinoSPAD:
 - 256 x 1 array
 - 64 FPGA- based 25 ps TDCs
- Piccolo:
 - 32 x 32 array
 - 128 column 49 ps TDCs
 - 224 Mevents/s
- Erdogan
 - 1024 x 16 array
 - 512 per-pixel 50 ps TDC
 - 16.5 Gevents/s

Piccolo, 32×32 CMOS SPAD for LIDAR





5 mm

Zhang, Sensors 18, 4016 (2018)

Conclusions

- These are a small fraction of the techniques being proposed for high resolution photon timing and imaging.
- As Heinz Graafsma stated yesterday, "You cannot develop the ultimate detector for every application" but there's so much more choice of devices now
- Largely because of the availability of custom miniaturized electronics: this has been disruptive for fast photon-counting timing and imaging techniques
- Another point (also repeated at PSD12): higher spatial and temporal resolution → much bigger datasets. How do we deal with these?
- Value of machine learning not only for calibration (ToT linearization per channel), event centroiding, and data reduction, but for data selection/analysis
- For space applications, this is especially important e.g. where distant planetary missions have heavily restricted telemetry bandwidth